19-2841; Rev 0; 4/03

3W Mono/Stereo BTL Audio Power Amplifiers with Shutdown

General Description

The MAX9710/MAX9711 are stereo/mono 3W bridge-tied load (BTL) audio power amplifiers. These devices are PC99/01 compliant, operate from a single 4.5V to 5.5V supply, and feature an industry-leading 100dB PSRR, which allows these devices to operate from noisy supplies without additional, costly power-supply conditioning. An ultra-low 0.005% THD+N ensures clean, low-distortion amplification of the audio signal while patented click-and-pop suppression eliminates audible transients on power and shutdown cycles. Power-saving features include low 2mV Vos (minimizing DC current drain through the speakers), low 7mA supply current, and a 0.5µA shutdown mode. A MUTE function allows the outputs to be quickly enabled or disabled.

These devices include thermal overload protection, are specified over the extended -40°C to +85°C temperature range, and are supplied in thermally efficient packages. The MAX9710 is available in either a 20-pin thin QFN package (5mm × 5mm × 0.8mm) or a 16-pin TSSOP-EP package. The MAX9711 is available in a 12pin thin QFN package (4mm × 4mm × 0.8mm).

Notebook PCs Flat-Panel TVs Flat-Panel PC Displays Applications

Two-Way Radios General-Purpose Audio Powered Speakers



_Features

- ♦ 3W into 3Ω (1% THD+N)
- 4W into 3Ω (10% THD+N)
- Industry-Leading, Ultra-High 100dB PSRR

捷多邦,专业PCB打样工厂,24小时加急出货

- PC99/01 Compliant
- Patented Click-and-Pop Suppression
- Low 0.005% THD+N
- Low Quiescent Current: 7mA
- Low-Power Shutdown Mode: 0.5µA
- MUTE Function
- Tiny 20-Pin Thin QFN (5mm × 5mm × 0.8mm) and 16-Pin TSSOP-EP Packages

Ordering Information

| PART | TEMP RANGE | PIN-PACKAGE | AMP |
|-----------------|----------------|-----------------|--------|
| MAX9710 ETP | -40°C to +85°C | 20-Thin QFN-EP* | Stereo |
| MAX9710EUE | -40°C to +85°C | 16-TSSOP-EP* | Stereo |
| MAX9711ETC | -40°C to +85°C | 12-Thin QFN-EP* | Mono |
| *EP = Exposed r | paddle. | | |

Simplified Block Diagram



_ Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at

ABSOLUTE MAXIMUM RATINGS

| V _{DD} to GND, PGND | +6V |
|--|----------------------------------|
| PV _{DD} to V _{DD} | ±0.3V |
| PGND to GND | ±0.3V |
| All Other Pins to GND | 0.3V to (V _{DD} + 0.3V) |
| Continuous Input Current (into any pin | |
| except power supply and output pins) | ±20mA |
| Continuous Power Dissipation ($T_{\Lambda} = +70^{\circ}$ | °C) |

12-Pin Thin QFN (derate 16.9mW/°C above +70°C)1349mW

16-Pin TSSOP-EP (derate 21.3mW/°C above +70°C)...1702mW 20-Pin Thin QFN (derate 20.8mW/°C above +70°C)1667mW Operating Temperature Range....-40°C to +85°C Storage Temperature Range-65°C to +150°C Junction Temperature+150°C Lead Temperature (soldering, 10s)+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = PV_{DD} = 5.0V, \text{ GND} = PGND = MUTE = 0V, V_{\overline{SHDN}} = 5V, R_{IN} = R_F = 15k\Omega, R_L = \infty$. T_A = T_{MIN} to T_{MAX}, unless otherwise noted. Typical values are at T_A = +25°C.) (Note 1)

| PARAMETER | SYMBOL | CON | DITIONS | MIN | ТҮР | МАХ | UNITS |
|--------------------------------|-----------------------------------|---------------------------------|---------------------------------|------|-------|------|-------|
| Supply Voltage Range | V _{DD} /PV _{DD} | Inferred from PSRR te | est | 4.5 | | 5.5 | V |
| Quiescent Supply Current | 1 | MAX9710 | | | 12 | 30 | |
| (IVDD + IPVDD) | IDD | MAX9711 | | | 7 | 17 | MA |
| Shutdown Supply Current | ISHDN | SHDN = GND | | | 0.5 | 30 | μA |
| | | $C_{BIAS} = 1\mu F (10\% of$ | final value) | | 300 | | 100.0 |
| rum-on nine | LON | $C_{BIAS} = 0.1 \mu F (10\% c)$ | of final value) | | 30 | | ms |
| Thermal Shutdown Threshold | | | | | 160 | | °C |
| Thermal Shutdown Hysteresis | | | | | 15 | | °C |
| OUTPUT AMPLIFIERS | | | | | | | |
| Output Offset Voltage | Vos | Vout_+ - Vout, Av = | = 2 | | ±2 | ±14 | mV |
| | | | $V_{DD} = 4.5V$ to 5.5V | 82 | 100 | | |
| Power-Supply Rejection Ratio | PSRR | $V_{RIPPLE} = 200 mV_{P-P}$ | f = 1kHz | | 87 | | dB |
| | | | f = 20kHz | | 74 | | |
| | | (| $R_L = 8\Omega$ | 1.1 | 1.4 | | |
| Output Power | Pout | I N = IKHZ, THD+N < 1% | $R_L = 4\Omega$ | | 2.6 | | W |
| | | | $R_L = 3\Omega$ | | 3 | | |
| Total Harmonic Distortion Plus | | f _{IN} = 1kHz, BW = | $P_{OUT} = 1.2W, R_L = 8\Omega$ | | 0.005 | | 0/ |
| Noise | | 22Hz to 22kHz | $P_{OUT} = 2W, 4\Omega$ | | 0.01 | | 70 |
| Signal-to-Noise Ratio | SNR | $R_L=8\Omega,V_{OUT}=2.8V_F$ | R_{MS} , BW = 22Hz to 22kHz | | 95 | | dB |
| Slew Rate | SR | | | | 1.6 | | V/µs |
| Maximum Capacitive Load Drive | CL | No sustained oscillati | ons | | 1 | | nF |
| Crosstalk | | $f_{IN} = 10 kHz$ | | | 77 | | dB |
| BIAS VOLTAGE (BIAS) | | | | | | | |
| BIAS Voltage | VBIAS | | | 2.35 | 2.5 | 2.65 | V |
| Output Resistance | R _{BIAS} | | | | 50 | | kΩ |
| DIGITAL INPUTS (MUTE, SHDN) | | | | | | | |
| Input Voltage High | VIH | | | 2 | | | V |
| Input Voltage Low | VIL | | | | | 0.8 | V |
| Input Leakage Current | l _{IN} | | | | | ±1 | μA |

Note 1: All devices are 100% production tested at +25°C. All temperature limits are guaranteed by design. **Note 2:** PSSR is specified with the amplifier inputs connected to GND through R_{IN} and C_{IN}.



Typical Operating Characteristics



M/IXI/N

MAX9710/MAX971

3



MAX9710/MAX971







Pin Description

| | PIN | | | |
|---------------|--------------|------------|-----------------|--|
| MAX | K9710 | MAX9711 | NAME | FUNCTION |
| 20-PIN QFN | 16-PIN TSSOP | 12-PIN QFN | | |
| 1 | 15 | _ | INL | Left-Channel Input |
| 2 | 16 | 7 | BIAS | DC Bias Bypass. See <i>BIAS Capacitor Selection</i> section for capacitor selection. |
| 3, 10, 13, 16 | | | N.C. | No Connection. Not internally connected. |
| 4 | 1 | 9 | MUTE | Active-High Mute Input |
| 5 | 2 | | INR | Right-Channel Input |
| 6, 11, 15, 20 | 3, 7, 10, 14 | 1, 3 | PGND | Power Ground |
| 7 | 4 | | OUTR+ | Right-Channel Bridged Amplifier Positive Output |
| 8, 18 | 5, 12 | 5, 11 | PVDD | Output Amplifier Power Supply |
| 9 | 6 | | OUTR- | Right-Channel Bridged Amplifier Negative Output |
| 12 | 8 | 8 | V _{DD} | Power Supply |
| 14 | 9 | 10 | SHDN | Active-Low Shutdown. Connect SHDN to VDD for normal operation. |
| 17 | 11 | _ | OUTL- | Left-Channel Bridged Amplifier Negative Output |
| 19 | 13 | _ | OUTL+ | Left-Channel Bridged Amplifier Positive Output |
| | — | 2 | IN | Amplifier Input |
| | _ | 6 | GND | Ground |
| | _ | 12 | OUT- | Bridged Amplifier Negative Output |
| | _ | 4 | OUT+ | Bridged Amplifier Positive Output |
| _ | | _ | EP | Exposed Pad. Connect to ground plane. |

Detailed Description

The MAX9710/MAX9711 are 3W BTL speaker amplifiers. The MAX9710 is a stereo speaker amplifier, while the MAX9711 is a mono speaker amplifier. Both devices feature a low-power shutdown mode, MUTE mode, and comprehensive click-and-pop suppression. These devices consist of high output-current op amps configured as BTL amplifiers (see *Functional Diagram*). The device gain is set by RF and RIN.

BIAS

These devices operate from a single 5V supply and feature an internally generated, power-supply-independent, common-mode bias voltage of 2.5V referenced to ground. BIAS provides both click-and-pop suppression and sets the DC bias level for the audio outputs. BIAS is internally connected to the noninverting input of each speaker amplifier (see *Functional Diagram*). Choose the value of the bypass capacitor as described in the *BIAS Capacitor* section. No external load should be applied to BIAS. Any load lowers the BIAS voltage, affecting the overall performance of the device.

Shutdown

The MAX9710/MAX9711 feature a 0.5 μ A low-power shutdown mode that reduces quiescent current consumption. Pulling SHDN low disables the device's bias circuitry, the amplifier outputs are actively pulled low, and BIAS is driven to GND. Connect SHDN to V_{DD} for normal operation.

MUTE Both devices feature a clickless/popless MUTE mode. When the device is muted, the input disconnects from the amplifier. MUTE only affects the power amplifiers and does not shut down the device. Drive MUTE high to mute the device. Drive MUTE low for normal operation.

Click-and-Pop Suppression

The MAX9710/MAX9711 feature Maxim's patented comprehensive click-and-pop suppression. During startup, the common-mode bias voltage of the amplifiers slowly ramps to the DC bias point using an S-shaped waveform. When entering shutdown, the amplifier outputs are actively driven low simultaneously. This scheme minimizes the energy present in the audio band.

For optimum click-and-pop suppression, choose:

 $R_{IN} \times C_{IN} < R_{BIAS} \times C_{BIAS}$

where RBIAS = $50k\Omega$.



Applications Information

BTL Amplifier

The MAX9710/MAX9711 are designed to drive a load differentially, a configuration referred to as BTL. The BTL configuration (Figure 1) offers advantages over the single-ended configuration, where one side of the load is connected to ground. Driving the load differentially doubles the output voltage compared to a single-ended amplifier under similar conditions. Thus, the differential gain of the device is twice the closed-loop gain of the input amplifier. The effective gain is given by:

$$A_{VD} = 2 \times \frac{R_F}{R_{IN}}$$

Substituting 2 x V_{OUT}(P-P) for V_{OUT}(P-P) into the following equations yields four times the output power due to doubling of the output voltage:

$$V_{RMS} = \frac{V_{OUT}(P-P)}{2\sqrt{2}}$$
$$P_{OUT} = \frac{V_{RMS}^{2}}{R_{I}}$$

Since the differential outputs are biased at midsupply, there is no net DC voltage across the load. This eliminates the need for DC-blocking capacitors required for single-ended amplifiers. These capacitors can be large, expensive, consume board space, and degrade low-frequency performance.



Power Dissipation and Heat Sinking

Under normal operating conditions, the MAX9710/ MAX9711 dissipate a significant amount of power. The maximum power dissipation for each package is given in the *Absolute Maximum Ratings* section under Continuous Power Dissipation or can be calculated by the following equation:

$$P_{\text{DISSPKG}(\text{MAX})} = \frac{T_{\text{J}(\text{MAX})} - T_{\text{A}}}{\theta_{\text{JA}}}$$

where T_J(MAX) is +150°C, T_A is the ambient temperature, and θ_{JA} is the reciprocal of the derating factor in °C/W as specified in the *Absolute Maximum Ratings* section. For example, θ_{JA} of the 20-pin thin QFN package is 48.1°C/W.

The increase in power delivered by the BTL configuration directly results in an increase in internal power dissipation over the single-ended configuration. The maximum power dissipation for a given V_{DD} and load is given by the following equation:

$$P_{\text{DISS}(\text{MAX})} = \frac{2V_{\text{DD}}^2}{\pi^2 R_{\text{I}}}$$

If the power dissipation for a given application exceeds the maximum allowed for a given package, either reduce V_{DD}, increase load impedance, decrease the ambient temperature, or add heat sinking to the device (see *Layout and Grounding* section). Large output, supply, and ground PC board traces improve the maximum power dissipation in the package.

Thermal-overload protection limits total power dissipation in the MAX9710/MAX9711. When the junction temperature exceeds +160°C, the thermal protection circuitry disables the amplifier output stage. The amplifiers are enabled once the junction temperature cools by 15°C. A pulsing output under continuous thermal-overload conditions results as the device heats and cools.

Component Selection

Gain-Setting Resistors

External feedback components set the gain of both devices. Resistors R_F and R_{IN} (*Functional Diagram*) set the gain of the amplifier as follows:

$$A_{VD} = 2 \times \frac{R_F}{R_{IN}}$$

Input Filter

The input capacitor (C_{IN}), in conjunction with R_{IN} , forms a highpass filter that removes the DC bias from an incoming signal. The AC-coupling capacitor allows the amplifier to bias the signal to an optimum DC level. Assuming zero-source impedance, the -3dB point of the highpass filter is given by:

$$f_{-3dB} = \frac{1}{2\pi R_{IN}C_{IN}}$$

For optimum click-and-pop suppression, choose:

$$RIN \times CIN < RBIAS \times CBIAS$$

where $R_{BIAS} = 50 k\Omega$.

Setting f-3dB too high affects the low-frequency response of the amplifier. Use capacitors with dielectrics that have low-voltage coefficients, such as tantalum or aluminum electrolytic. Capacitors with high-voltage coefficients, such as ceramics, may result in an increase of distortion at low frequencies.

BIAS Capacitor

BIAS is the output of the internally generated 2.5VDC bias voltage. The BIAS bypass capacitor, C_{BIAS}, improves PSRR and THD+N by reducing power supply and other noise sources at the common-mode bias node, and also generates the clickless/popless startup DC bias waveform for the speaker amplifiers. Bypass BIAS with a 1µF capacitor to GND. Smaller values of C_{BIAS} produce faster t_{ON}/t_{OFF} times but may result in increased click/pop levels.

Supply Bypassing

Proper power-supply bypassing ensures low-noise, low-distortion performance. Place a 0.1μ F ceramic capacitor from V_{DD} to PGND. Add additional bulk capacitance as required by the application. Locate the bypass capacitor as close to the device as possible.

Piezoelectric Speaker Driver

Low-profile piezoelectric speakers can provide quality sound for portable electronics. However, piezoelectric speakers typically require large voltage swings (>8VP-P) across the speaker element to produce audible sound pressure levels. The MAX9711 can be configured to drive a piezoelectric speaker with up to 10VP-P while operating from a single 5V supply.

Figure 2 shows the THD+N of the MAX9711 driving a piezoelectric speaker. Note that as frequency increases, the THD+N increases. This is due to the capacitive nature of the piezoelectric speaker; as frequency increases, the speaker impedance decreases, resulting in a larger current draw from the amplifier.





Figure 2. MAX9711 Piezoelectric Speaker Driver THD+N vs. Frequency

The capacitive nature of the piezoelectric speaker may cause the MAX9711 to become unstable. A simple inductor/resistor network in series with the speaker isolates the speaker capacitance from the driver and ensures that the device output sees a resistive load of about 10Ω at high frequency, thereby maintaining stability (Figure 3).

Layout and Grounding

Good PC board layout is essential for optimizing performance. Use large traces for the power-supply inputs and amplifier outputs to minimize losses due to parasitic trace resistance and route heat away from the device. Good grounding improves audio performance, minimizes crosstalk between channels, and prevents any digital switching noise from coupling into the audio signal.

The MAX9710/MAX9711 thin QFN and TSSOP-EP packages feature exposed thermal pads on their undersides. This pad lowers the thermal resistance of the package by providing a direct-heat conduction path from the die to the printed circuit board. Connect the exposed pad to the ground plane using multiple vias, if required. For optimum performance, connect to the ground planes as shown in Figure 4.



Figure 3. Isolation Network for Driving a Piezoelectric Speaker



Figure 4. MAX9710 Audio Ground Connection

MAX9710/MAX9711











_Chip Information

MAX9710 TRANSISTOR COUNT: 1172 MAX9711 TRANSISTOR COUNT: 780 PROCESS: BICMOS



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



| | | | | | СОММ | ON DI | MENS | SIONS | | | | | EXPC | ISED | PAD | VAF | RIATI | DNS | |
|---------------------------|--------------|----------|------------------|---------|----------|---------|-------------------|-------------------|------------|------|----------|------|---------|------|------|------|-------|------|-----|
| PKG | 1 | 2L 4×4 | \$ | 1 | 6L 4×4 | ł | 2 | 0L 4×4 | 4 | 6 | 24L 4× | 4 | PKG | | D2 | | | E2 | |
| REF. | MIN. | NDM. | MAX. | MIN. | NDM. | MAX. | MIN. | NDM. | MAX. | MIN. | NDM. | MAX. | CODES | MIN. | NDM. | MAX. | MIN. | NDM. | MA) |
| A | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | T1244-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.2 |
| Al | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 | 0.0 | 0.02 | 0.05 | T1644-2 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.2 |
| A2 | | 0.20 REF | - | | 0.20 REF | | (| 0.20 REF | | | 0.20 REF | | T2044-1 | 1.95 | 2.10 | 2.25 | 1.95 | 2.10 | 2.2 |
| b | 0.25 | 0.30 | 0.35 | 0.25 | 0.30 | 0.35 | 0.20 | 0.25 | 0.30 | 0.18 | 0.23 | 0.30 | T2444-1 | 2.45 | 2.60 | 2.63 | 2.45 | 2.60 | 2.6 |
| D | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | | | | | | | |
| Ε | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | 3.90 | 4.00 | 4.10 | | | | | | | |
| e | | 0.80 BS | 2. | | 0.65 BSC | | | 0.50 BSC | 2 | | 0.50 BSC | 2 | | | | | | | |
| ĸ | 0.25 | - | - | 0.25 | - | - | 0.25 | - | - | 0.25 | - | - | | | | | | | |
| L | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.30 | 0.40 | 0.50 | | | | | | | |
| N | | 12 | | | 16 | | | 20 | | | 24 | | | | | | | | |
| ND | | 3 | | | 4 | | | 5 | | | 6 | | | | | | | | |
| NE | | 3 | | | 4 | | | 5 | | | 6 | | | | | | | | |
| Var. | | WGGB | | | WGGC | | | WGGD- | 1 | | WGGD- | 2 | J | | | | | | |
| NOTES: 1. DII 2. AL | : MENSIOI | NING & | TOLERAI | NCING C | ONFORM | to asmi | E Y14.5 F IN D | 5M-1994 FGREES | . . | | | | | | | | | | |
| Z. AL | | TOTAL | | OF TEL | DUINAI S | GLLS AR | | LONCES. | | | | | | | | | | | |
| 7 N | | | THE OWNER PLATER | 100 100 | | | | | | | | | | | | | | | |

INE V THIN, 4x4x0.8 mr

21-0139

A 2/2

DIMENSION 5 APPLIES TO METALLIZED TERMINAL AND IS MEASURED BETWEEN 0.25 mm AND 0.30 mm
 FROM TERMINAL TIP.

M AND NE REFER TO THE NUMBER OF TERMINALS ON EACH D AND E SIDE RESPECTIVELY.

DEPOPULATION IS POSSIBLE IN A SYMMETRICAL FASHION.

COPLANARITY APPLIES TO THE EXPOSED HEAT SINK SLUG AS WELL AS THE TERMINALS.
9. DRAWING CONFORMS TO JEDEC M0220.



Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <u>www.maxim-ic.com/packages</u>.)



| | | | | CC | DWWOR | | NSIO | NS | | | | | | | | | ND V/ | | | |
|--|--|--|---|---|---|--|---|---|--|---|---|--|------|-------------------------------------|----------|----------------|-------|------|---------|------------|
| PKG. | | 16L 5x5 | | | 20L 5x5 | | | 28L 5x5 | i | | 32L 5x5 | | Ī | PKG. | | D2 | | | E2 | |
| SYMBOL | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | MIN. | NOM. | MAX. | ļ | ODES | MIN. | NOM. | MAX. | MIN. | NOM. | MA |
| Α | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | 0.70 | 0.75 | 0.80 | | 1655-1 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.2 |
| A1 | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | 0 | 0.02 | 0.05 | _ Lī | 2055-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.2 |
| A3 | | 0.20 REF | | (| 0.20 REF | | (| 0.20 RE | F. | (| 0.20 REF | | - 12 | 2855-1 | 3.15 | 3.25 | 3.35 | 3.15 | 3.25 | 3.3 |
| b | 0.25 | 0.30 | 0.35 | 0.25 | 0.30 | 0.35 | 0.20 | 0.25 | 0.30 | 0.20 | 0.25 | 0.30 | 밑 | 2855-2 | 2.60 | 2.70 | 2.80 | 2.60 | 2.70 | 2.8 |
| D | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | | 3255-2 | 3.00 | 3.10 | 3.20 | 3.00 | 3.10 | 3.2 |
| E | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | 4.90 | 5.00 | 5.10 | | | | | | | | |
| 0 | | 0.80 BS | <u>).</u> | | 0.65 BS | <u>c.</u> | | 0.50 BS | iC. | | 0.50 BS | <u>, </u> | | | | | | | | |
| k | 0.25 | - | • | 0.25 | - | • | 0.25 | • | • | 0.25 | - | - | | | | | | | | |
| L | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.45 | 0.55 | 0.65 | 0.30 | 0.40 | 0.50 | | | | | | | | |
| N | | 16 | | | 20 | | | 28 | | | 32 | | | | | | | | | |
| ND | | 4 | | | 5 | | | -1- | | | 8 | | | | | | | | | |
| NE | | - | | | 9 | | | | | | • | | | | | | | | | |
| JEDEC | | WHHB | | | WHHC | | | WHHD | -1 | | WHHD | -2 | | | | | | | | |
| DTES: 1. DIME 2. ALL D 3. N IS T 4. THE T | NSIONIN DIMENSIO THE TOT. | WHHB IG & TOLI DNS ARE AL NUME AL #1 IDE | ERANCIN IN MILLI IER OF T NTIFIER | NG CONI METERS ERMINA AND TE | FORM TC S. ANGLE ALS. RMINAL I |) ASME 1 S ARE II | Y14.5M- N DEGF | WHHD -1994. REES. | -1 | ALL CON | | -2 | 5-1 | | | | | | | |
| DTES: 1. DIME 2. ALL D 3. N IS 1 4. THE 1 SPP-0 ZONE | NSIONIN DIMENSIO THE TOT. TERMINA D12. DET INDICA | WHHB IG & TOLI DNS ARE AL NUMB AL NUMB FAILS OF TED. THE | ERANCIN IN MILLI SER OF T NTIFIER TERMIN TERMIN | NG CONI METERS ERMINA AND TE AL #1 ID JAL #1 II | WHHC FORM TO S. ANGLE ALS. RMINAL I JENTIFIE DENTIFIE |) ASME ' S ARE II NUMBER R ARE O ER MAY E | Y14.5M- N DEGF RING CC PTIONA BE EITH | WHHD 1994. REES. DNVENTI AL, BUT I IER A MO | ION SHA MUST B DLD OR | ALL CON E LOCA" MARKE | IFORM TI FED WITH D FEATU | O JESD 9 IIN THE RE. | 5-1 | | | | | | | |
| DTES: 1. DIME 2. ALL D 3. N IS T SPP-C ZONE DIME FROM | NSIONIN DIMENSIO THE TOT, TERMINA D12. DET SINDICA NSION b M TERMII | WHHB IG & TOLI DNS ARE AL NUME AL #1 IDE TAILS OF TED. THE APPLIES NAL TIP. | ERANCIN IN MILLI ER OF T NTIFIER TERMIN TERMIN TO MET | NG CONI METERS ERMINA AND TE AL #1 ID VAL #1 II VAL #1 II FALLIZEI | WHHC FORM TO S. ANGLE ALS. RMINAL I ENTIFIER DENTIFIER DENTIFIER | O ASME N S ARE II NUMBER R ARE O IR MAY E NAL AND | Y14.5M- N DEGR RING CC PTION BE EITH SE EITH SE EITH | WHHD -1994. REES. DNVENTI AL, BUT M IER A MO ASURED | ION SHA MUST B DLD OR BETWE | ALL CON E LOCA MARKE EN 0.25 | IFORM TO FED WITH D FEATU TIMM AND | 0 JESD 96 11N THE RE. 0 0.30 mm | 5-1 | | | | | | | |
| TTES: 1. DIME 2. ALL D 3. N IS T 4. THE 1 SPP-(ZONE 5. DIME FROM 6. ND AI | NSIONIN DIMENSIO THE TOT. TERMINA D12. DET INDICA NSION b M TERMII ND NE R | WHHB IG & TOLI DNS ARE AL NUME L #1 IDE TAILS OF TED. THE APPLIES NAL TIP. EFER TO | ERANCIN IN MILLI SER OF T NTIFIER TERMIN TERMIN TO MET | NG CONI METERS ERMINA AND TE AL #1 ID VAL #1 II FALLIZEI MBER C | WHHC FORM TC S. ANGLE ALS. RMINAL I DENTIFIED DENTIFIED D TERMIN | O ASME S S ARE II NUMBER R ARE O IR MAY E NAL ANE | Y14.5M N DEGR PTIONA BE EITH N IS MEA | WHHD 1994. REES. DNVENTI LER A MO ASURED | ION SHA MUST B DLD OR BETWE | ALL CON E LOCA' MARKE EN 0.25 RESPEC | IFORM TI TED WITH D FEATU mm ANE | 0 JESD 95 11N THE RE. 0 0.30 mm | 5-1 | | | | | | | |
| TTES: 1. DIME 2. ALL D 3. NIST 4. THE 1 SPP-C ZONE 5. DIME FROM 6. ND AI 7. DEPC | NSIONIN DIMENSIO THE TOT. TERMINA D12. DET INDICA NSION b M TERMIN ND NE R DPULATIO | WHHB IG & TOLI DNS ARE AL NUME L #1 IDE TAILS OF TED. THE APPLIES NAL TIP. EFER TO DN IS PO | ERANCIN IN MILLI ER OF T NTIFIER TERMIN TERMIN TO MET | NG CONI METERS ERMINA AND TE AL #1 ID IAL #1 II FALLIZEI MBER C N A SYM | WHHC FORM TO S. ANGLE S. ANGLE S. ANGLE S. ANGLE DENTIFIED DENTIFIED DENTIFIED DENTIFIED DENTIFIED DENTIFIED | O ASME S S ARE II NUMBER R ARE O R MAY E NAL ANE NAL S OI NAL FASH | Y14.5M N DEGR PTION BE EITH D IS ME/ N EACH HON. | -1994. REES. DNVENTIAL, BUT I IER A MO ASURED | | ALL CON E LOCA MARKE EN 0.25 RESPEC | IFORM TI TED WITH D FEATU TIVELY. | -2 O JESD 95 11N THE RE. 0 0.30 mm | 5-1 | | | | | | | |
| TES: 1. DIME 2. ALL D 3. NIST 3. NIST 3. PT-C 2. ONE 5. DIME 6. ND AI 7. DEPC 6. COPL | NSIONIN DIMENSIC TERMINA D12. DET E INDICA NSION b M TERMII ND NE R DPULATIC ANARIT | WHHB IG & TOLI DNS ARE AL NUME AL HI IDE TAILS OF TED. THE APPLIES NAL TIP. EFER TO DN IS PO Y APPLIE | ERANCIN IN MILLI ER OF T NTIFIER TERMIN TERMIN TO MET | NG CONI METERS ERMINA AND TE AL #1 ID JAL #1 II TALLIZEI MBER C N A SYN E EXPO | WHHC FORM TC S. ANGLE ULS. RMINAL I DENTIFIE DENTIFIE DENTIFIE DENTIFIE DENTIFIE DENTIFIE SED HEA | O ASME S S ARE II NUMBER R ARE O R MAY E NAL ANE NAL ANE NAL S OI SAL FASH T SINK S | Y14.5M N DEGR N DEGR PTIONA BE EITH N EACH HON. SLUG A | - 1994. REES. DNVENTIAL, BUT I IER A MO ASURED I D AND S WELL | ION SHA MUST B DLD OR BETWE E SIDE | ALL CON E LOCAT MARKE EEN 0.25 RESPEC | WHHD IFORM TH FED WITH D FEATU mm ANE CTIVELY. | -2 O JESD 95 41N THE RE. 0 0.30 mm | 5-1 | | | MATION | | | | ۲. ۲ |
| TES: 1. DIME 2. ALL D 3. NIST SPP-C ZONE DIME FROM 0. ND AI 7. DEPC 0. COPL 9. DRAV | NSIONIN DIMENSIO THE TOT. TERMINA D12. DET I INDICA NSION b M TERMII ND NE R DPULATIO ANARIT VING CO | WHHB IG & TOLI DNS ARE AL NUME LL #1 IDE TAILS OF TED. THE APPLIES NAL TIP. EFER TO ON IS PO Y APPLIE NFORMS | ERANCIN IN MILLI IER OF T NTIFIER TERMIN TERMIN TO MET THE NU SSIBLE I S TO TH S TO JED | NG CONI METERS ERMINA AND TE AL #1 ID JAL #1 II TALLIZEI MBER C N A SYN E EXPO EC MO2 | FORM TC S. ANGLE S. ANGLE S. ANGLE SENTIFIE DENTIFIE DENTIFIE DENTIFIE DENTIFIE DENTIFIE DENTIFIE SED HEA 20. | O ASME S S ARE II NUMBER R ARE O NAL ANE NAL ANE INALS OI AL FASH S SINK S | Y14.5M N DEGR PTIONS CC DTIONS E EITH N EACH 4ION. SLUG A | ASURED | ION SHA MUST B DLD OR BETWE E SIDE | ALL CON E LOCAT MARKE EEN 0.25 RESPEC | WHHD FORM TH FED WITH D FEATU TO FEATU TO FEATU TO FEATU TO T | -2 O JESD 96 HIN THE RE. 0 0.30 mm | 5-1 | | | MATION | | | | ' L |
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Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to <u>www.maxim-ic.com/packages</u>.)



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